MSKSEMI















ESD

TVS

TSS

MOV

GDT

PLED

Broduct data sheet



Features

- ◆ 250 Watts peak pulse power (tp = 8/20µs)
- ◆ Transient protection for high speed data lines to IEC 61000-4-2 (ESD) ±30kV (air), ±30kV (contact) IEC 61000-4-4 (EFT) 40A (5/50ns)
- ◆ Protects One Power or I/O Port
- Low operating and clamping voltages
- Solid-state silicon avalanche technology

1 2

SOD-523

Applications

- Notebooks, Desktops, Servers and Video Graphics Cards
- ◆ USB Power & Data Line Protection
- Monitors and Flat Panel Displays
- ◆ I²C Bus Protection
- ◆ Portable Instrumentation
- ♦ Set Top Box

Maximum Rating @ Ta=25°C unless otherwise specified

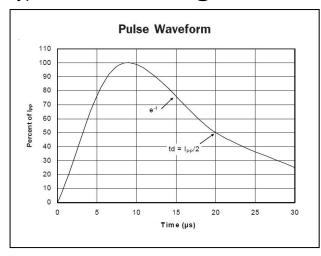
Symbol	Parameter	Ratings	Units
P _{PK}	Peak Pulse Power (tp = 8/20μs)	250	Watts
TL	Lead Soldering Temperature	260(10sec.)	$^{\circ}$
TJ	Operating Temperature	-55 to +125	$^{\circ}$
T _{STG}	Storage Temperature	-55 to +150	${\mathbb C}$

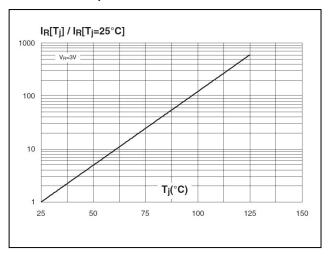
Electrical Characteristics@ Ta=25°C unless otherwise

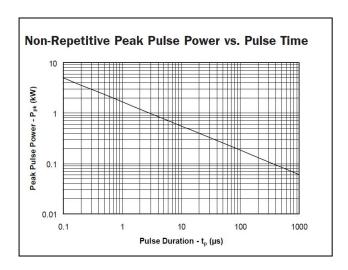
	VRWM @IR		VBR@ImA	VC@1	VC@IPP		C1
P/N	V	μА	V	V	V	Α	pF
		MAX	MIN	MAX	MAX		MAX
PESD3V3S1UB-MS	3.3	1	4	9.8	13	12	120
PESD5V0S1UB-MS	5	1	5.8	11.8	15	10	100
PESD7V0S1UB-MS	7	1	7.5	14	19	8	80
PESD12VS1UB-MS	12	1	13.3	19	25	6	70
PESD15VS1UB-MS	15	1	16.5	24	33	5	50
PESD24VS1UB-MS	24	1	26.1	44	54	3	30
PESD36VS1UB-MS	36	1	38.2	62	80	3	30

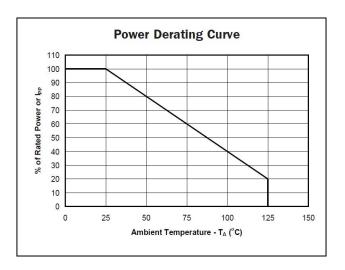


Typical Characteristics@ Ta=25°C unless otherwise specified



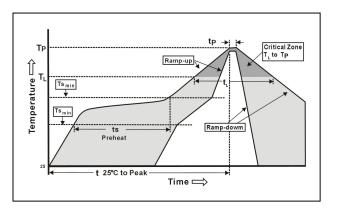






Soldering Parameters

Reflow Condition		Fb – Free assembly	
	-Temperature Min (T _{s(Min)})	150°C	
Pre Heat	- Temperature Max (T _{s(Max)})	200°C	
	-Time (Min to max) (t _s)	60 – 180 secs	
Average ra (T _L) to pea	amp up rate (Liquidus) Temp k	3°C/second Max	
T _{s (Max)} to T _L - Ramp-up Rate		3°C/second Max	
Reflow	-Temperature (T _L) (Liquidus)	217°C	
	-Temperature (t _L)	60 – 150 seconds	
Peak Temperature (T _p)		250+0/-5 °C	
Time within 5°C of actual peak Temperature (t _p)		20 – 40 seconds	
Ramp-dowm Rate		6°C/second Max	
Time 25°C	to peak Temperature (T _p)	8 minutes Max.	
Do not exc	eed	260°C	
·	<u> </u>	·	



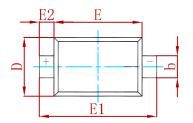


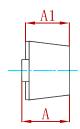


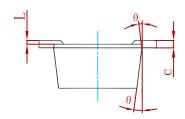






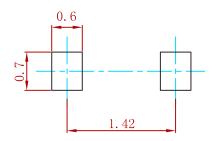






Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	0.510	0.770	0.020	0.031	
A1	0.500	0.700	0.020	0.028	
b	0.250	0.350	0.010	0.014	
С	0.080	0.150	0.003	0.006	
D	0.750	0.850	0.030	0.033	
E	1.100	1.300	0.043	0.051	
E1	1.500	1.700	0.059	0.067	
E2	0.200 REF		0.008 REF		
Ш	0.010	0.070	0.001	0.003	
θ	7° RFF		7° F	RFF	

Suggested Pad Layout



Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.

REEL SPECIFICATION

P/N	PKG	QTY
PESDXXXS1UB-MS	SOD-523	3000



Semiconductor



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